**SUBSTITUTE STATEMENT UNDER 37 CFR 1.64**

**For Application with Filing Date on or after September 16, 2012**

This Substitute Statement is directed to:  The application attached hereto, or

United States Application, or the U.S. National Phase of PCT International Application, No.            filed on                .

The legal name of the inventor or joint inventor with respect to whom this Substitute Statement in lieu of an oath or declaration is executed is:                               .

As the below named applicant in the above-identified application, on information and belief, I hereby declare that:

I believe the above-named inventor or joint inventor to be the original inventor or an original joint inventor of a claimed invention in the above-identified application.

The above-identified application was made or authorized to be made by me.

I have reviewed and understand the contents of the above-identified application, including the claims, and am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR §1.56.

I hereby acknowledge that any willful false statement made in this Substitute Statement is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

My relationship to the above-named inventor or joint inventor with respect to whom this Substitute Statement is executed is:

Legal Representative (for deceased or legally incapacitated inventor only),

Assignee,

Person to whom the above-named inventor is under an obligation to assign,

Person who otherwise shows a sufficient proprietary interest in the matter (petition under 37 CFR 1.46 is required), or

Joint Inventor.

The circumstance permitting the below named applicant to execute and file the Substitute Statement is:

Inventor is deceased,

Inventor is under legal incapacity,

Inventor cannot be found or reached after diligent effort, or

Inventor has refused to execute the oath or declaration under 37 CFR 1.63.

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| **Typewritten Legal  Name Of Applicant** |  |  |
|  |  |  |
| Signature: |  |  |
|  |  |  |
| Typewritten Name: |  |  |
| Title (if acting on behalf of |  |  |
| a corporate applicant): |  |  |
|  |  |  |
| **[[1]](#footnote-1)\*** Residence (city & country): |  |  |
|  |  |  |
| \* Mailing Address: |  |  |

1. \* Not required if information is provided in an Application Data Sheet. [↑](#footnote-ref-1)